



Product Change Notification

Change Notification #: 117722 - 00

Change Title: Intel® NUC Rugged Board Element CMB1ABC,
Intel® NUC Rugged Chassis Element CMCR1ABC,
PCN 117722-00, Label,
Label Updates

Date of Publication: July 31, 2020

Key Characteristics of the Change:

Label

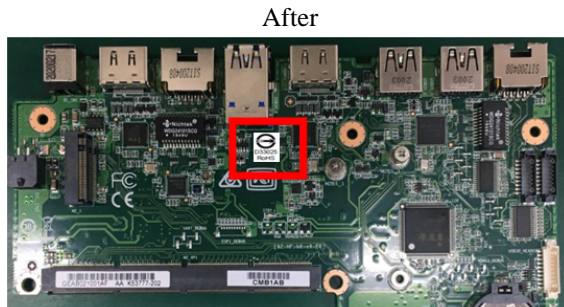
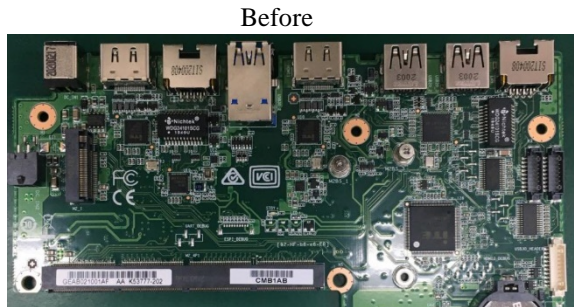
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	August 31, 2020
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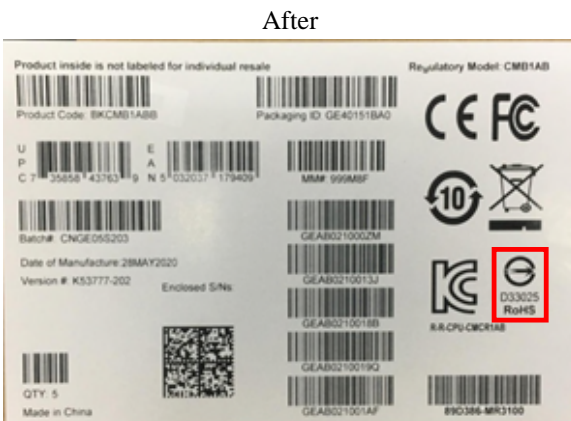
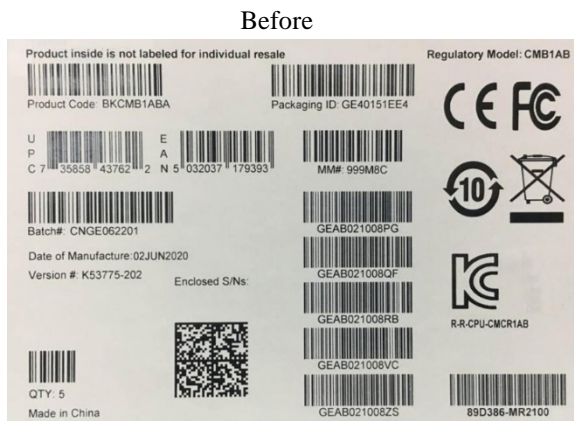
Description of Change to the Customer:

The Intel® NUC Rugged Board Element CMB1ABC SKU, listed in the products affected table below, will have the following changes:

1. Add BSMI logo to carrier board.



2. Add BSMI logo to carrier board carton label.



The Intel® NUC Rugged Chassis Element CMC1ABC SKUs, listed in the products affected table below, will have the following changes:

1. Add BSMI logo and carrier board serial number to kit rating label.



2. Add BSMI logo to kit carton label.



5. Change kit power adapter for Erp Lot 3



Customer Impact of Change and Recommended Action:

The change to the labels does not affect the functionality of the product. Customer should be aware of these changes and take any actions so as to not impact their receiving and integration of product with the new label.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BKCMB1ABC	999M8M		K53779-302		K53779-303
BKCMCR1ABC	999M9A	K53784-302		K53784-303	
BKCMCR1ABC1	999M9C	K53784-302		K53784-303	
BKCMCR1ABC2	999M9D	K53784-302		K53784-303	

PCN Revision History:

Date of Revision:

July 31, 2020

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

117722 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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